

Special Issue

Recent Development and Emerging Trends in Dental Implants

Message from the Guest Editors

The journal article on “Recent Developments and Emerging Trends in Dental Implants” explores cutting-edge advancements in implant technology, materials, and techniques. It highlights innovative approaches such as digital dentistry, 3D printing, and biocompatible materials that enhance patient outcomes. The article also discusses trends like minimally invasive procedures and personalized treatment plans, emphasizing their impact on the future of dental implantology. This comprehensive overview is essential for dental professionals aiming to stay updated in this rapidly evolving field.

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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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